5

Δ

DBV PACKAGE (TOP VIEW)

А

GND 3

B 🛛 2

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□ v_{cc}

- Operating Range 2-V to 5.5-V V_{CC}
- *EPIC*[™] (Enhanced-Performance Implanted CMOS) Process
- High Latch-Up Immunity Exceeds 250 mA Per JESD 17
- Packaged in Plastic Small-Outline Transistor Package

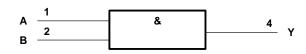
description

The SN74AHC1G08 is a single 2-input positive-AND gate. The device performs the Boolean function $Y = A \bullet B$ or $Y = \overline{\overline{A} + \overline{B}}$ in positive logic.

The SN74AHC1G08 is characterized for operation from -40°C to 85°C.

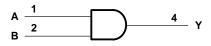
_	FUNCTION TABLE								
	INP	UTS	OUTPUT						
	Α	В	Y						
	Н	Н	Н						
	L	Х	L						
	Х	L	L						

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1) Input clamp current, I_{IK} ($V_I < 0$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Package thermal impedance, θ_{IA} (see Note 2)	0.5 V to 7 V 0.5 V to V _{CC} + 0.5 V 0 mA 20 mA 25 mA 50 mA
Package thermal impedance, θ_{JA} (see Note 2)	347°C/W

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
	V _{CC} = 2 V		1.5		
VIH	High-level input voltage	V _{CC} = 3 V	2.1		V
		V _{CC} = 5.5 V	3.85		
		$V_{CC} = 2 V$		0.5	
VIL	L Low-level input voltage	$V_{CC} = 3 V$		0.9	V
		V _{CC} = 5.5 V		1.65	
VI	Input voltage		0	5.5	V
VO	Output voltage		0	VCC	V
		$V_{CC} = 2 V$		-50	μA
ЮН	High-level output current	V_{CC} = 3.3 V ± 0.3 V	-4		mA
	H High-level output current	V_{CC} = 5 V ± 0.5 V		-8	ША
		$V_{CC} = 2 V$		50	μA
IOL	Low-level output current	V_{CC} = 3.3 V ± 0.3 V		4	mA
	Output voltage	$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		8	mA
A #/ A	lanut transition rice or fell rete	V_{CC} = 3.3 V ± 0.3 V		100	20/1
ΔυΔν	input transition rise of rail fate	V_{CC} = 5 V ± 0.5 V		20	ns/V
ТА	Operating free-air temperature		-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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otherwise noted)		ating i		temp	Joratt		inge (unicoo
PARAMETER	TEST CONDITIONS	Vee	T _A = 25°C			MIN	МАХ	UNIT
FARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX		INIAA	UNIT
		2 V	1.9	2		1.9		

electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					•	•	•

			00	MIN	TYP	MAX		
			2 V	1.9	2		1.9	
		I _{OH} = -50 μA	3 V	2.9	3		2.9	
Vон			4.5 V	4.4	4.5		4.4	V
•		$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48	
		I _{OH} = -8 mA	3.94			3.8		
						0.1	0.1	
		I _{OL} = 50 μA	3 V			0.1	0.1	
VOL			4.5 V			0.1	0.1	V
		I _{OL} = 4 mA	3 V	3 V 0.36		0.44		
		I _{OL} = 8 mA	4.5 V			0.36	0.44	
Ц	A or B inputs	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1	±1	μΑ
ICC		$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			1	10	μΑ
Ci		$V_I = V_{CC}$ or GND	5 V		4	10	10	pF

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	OUTPUT CAPACITANCE	T _A = 25°C			MIN	мах	UNIT
					MIN	TYP	MAX		IVIAA	
	^t PLH	A or B	Y	C _L = 15 pF		6.2	8.8	1	10.5	20
	^t PHL					6.2	8.8	1	10.5	ns
	^t PLH	A or B	V	C _L = 50 pF		8.7	12.3	1	14	20
	^t PHL		Ť			8.7	12.3	1	14	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

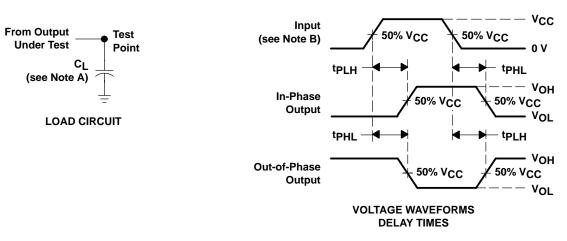
PARAMETER	FROM (INPUT)	TO (OUTPUT)	OUTPUT CAPACITANCE	T _A = 25°C			MIN	мах	UNIT
PARAMETER				MIN	TYP	MAX		IVIAA	UNIT
^t PLH	A or B	Y	C _L = 15 pF		4.3	5.9	1	7	ns
^t PHL					4.3	5.9	1	7	
^t PLH	A or B	V	C _L = 50 pF		5.8	7.9	1	9	20
^t PHL		ř			5.8	7.9	1	9	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CO	ONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load,	f = 1 MHz	18	pF



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns.
- C. The output is measured with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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